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# **Product Specifications Approval Sheet**

Product Description: Dielectric Filter 5825MHz BW 200MHz Size 8.6x3.35mm TST Parts No.: TR0130AA0090

Customer Parts No.:\_\_\_\_\_

Customer signature required			
Company:			
Company.			
Division:			
Approved by :			
Date:			
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Checked by:	Nina Chen	Nina Che Kasuma d	N
		[	
Approved by:	Kazuma Lee	Kazuma d	
Data:	2022/07/07		
Date:	2023/07/07		

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.



# TAI-SAW TECHNOLOGY CO., LTD.

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# Dielectric Filter 5825MHz BW 200MHz Size 8.6x3.35mm

MODEL NO.: TR0130AA0090

## A. Maximum Rating:

- 1. Input Power:1W
- 2. Operating Temperature: -40°C to +85°C
- 3. Storage Temperature: 0°C to +40°C
- 4. Moisture Sensitivity Level: 2a(MSL 2a)

# B. Electrical Characteristics:

**SPECIFICATION** ITEM Min Max Тур **INSERTION LOSS** 1.0 dB 5725~5925 MHz 1.5 dB RIPPLE 5725~5925 MHz 1.0 dB 1.2 dB **RETURN LOSS** 5725~5925 MHz 10 dB 12 dB **ATTENUATION** at 4995 MHz 35 dB 37dB ATTENUATION specifies the absolute value of attenuation.

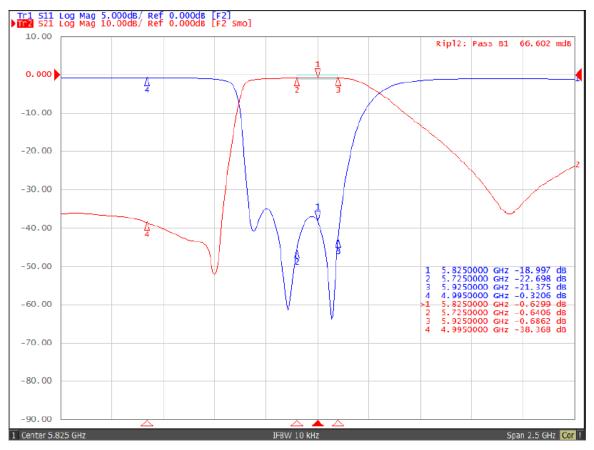
RoHS Compliant Lead free Lead-free soldering

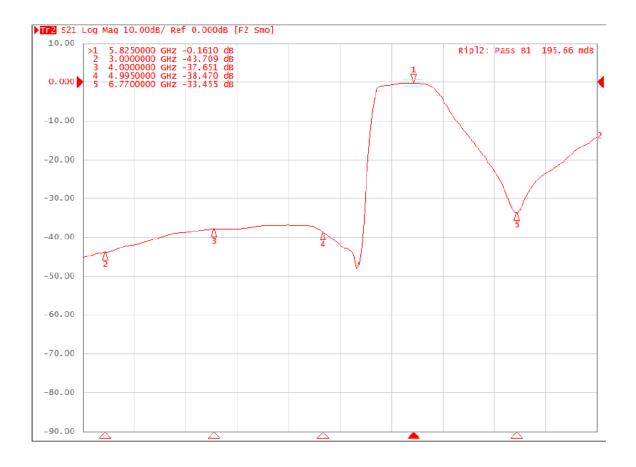
**REV. NO.:1.0** 

Electrostatic Sensitive Device (ESD)

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# C. Frequency Characteristics:

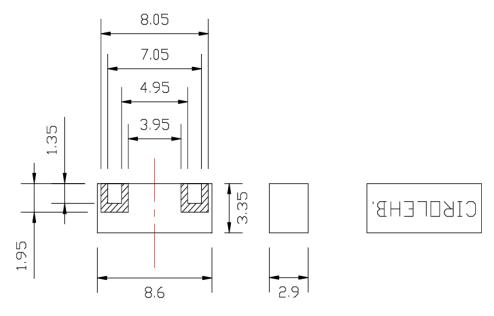




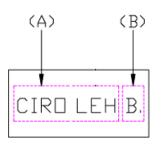
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TST DCC Release document

# D. Dimension:



Dimensions in mm Tolerance : ±0.25



(A) Product name : CIRO LEH (B) Year/Month : Please refer to the Table-1

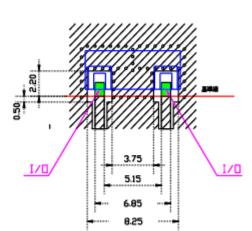
#### (Table-1)

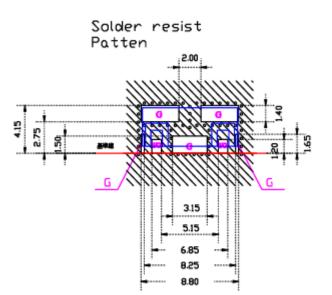
Year	Month	Code									
2012	1	Α	2013	1	N	2014	1	Α.	2015	1	Ν.
2016	2	В	2017	2	Р	2014	2	В.	2015	2	Ρ.
2020 2024	3	С	2021 2025	3	Q	2022 2026	3	с.	2023 2027	3	Q.
	4	D		4	R	2020	4	D.	2027	4	R.
	5	Е	]	5	S		5	Ε.		5	s.
	6	F	]	6	Т	1	6	F.	1	6	т.
	7	G	]	7	U		7	G.		7	U.
	8	Н	]	8	v		8	Н.		8	v.
	9	J	]	9	w		9	J.		9	w.
	10	K	]	10	х		10	К.		10	х.
	11	L		11	Y		11	L.		11	Υ.
	12	М		12	Ζ		12	М.		12	Ζ.

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### E. PCB Footprint:

Conductive Material Patten





Filter outline 00 Via hole

Electrode

I/D Pads must be connected to lineswith  $50\,\Omega$  impedance. in the application a termination of  $50\,\Omega$  must be realized.

Tolerance:±0.2 I/D:Input/Dutput G:Ground

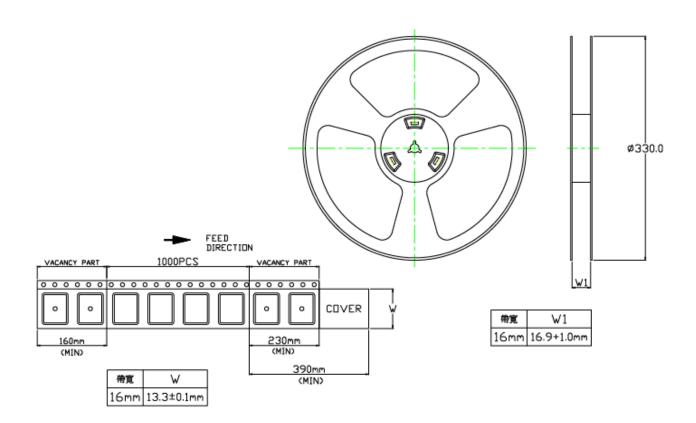
//////

Solder Resist

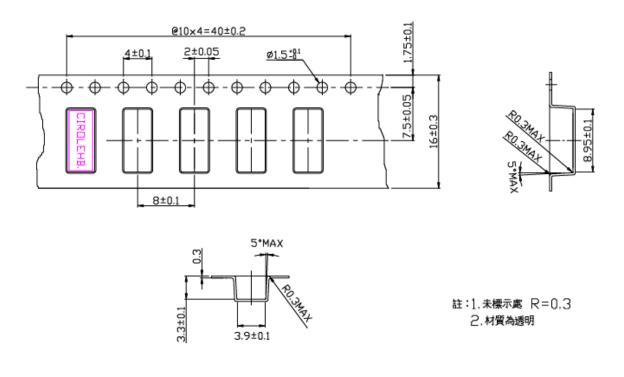
Solder LAND

## F.Packing:

1.Reel Dimension:



## 2. Tape Dimension:



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**TST DCC** Release document

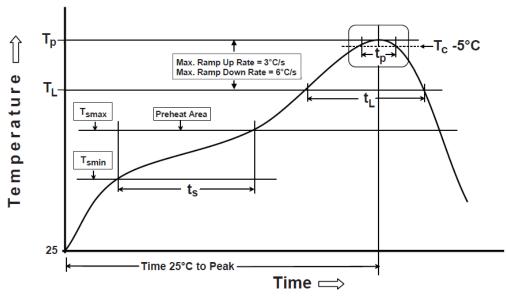
## G. Recommended Reflow Profile:

Products can be assembled following Pb-free assembly. According to the Standard **IPC/JEDEC J-STD-020C**, the temperature profile suggested is as follow:

Phase	Profile features	Pb-Free Assembly (SnAgCu)		
PREHEAT	-Temperature Min(Tsmin) -Temperature Max(Tsmax) -Time(ts) form (Tsmin to Tsmax)	150°C 200°C 60-120 seconds		
RAMP-UP	Avg. Ramp-up Rate (Tsmax to TP)	3°C/second(max)		
REFLOW	-Temperature(TL) -Total Time above TL (t L)	217°C 30-100 seconds		
PEAK	-Temperature(TP) -Time(tp)	260°C 3 second		
RAMP-DOWN	Rate	$6^{\circ}$ C / second max.		
Time from 25°C to Peak Temperature		8 minutes max.		
Composition of solder paste		96.5Sn/3Ag/0.5Cu		
Solder Paste Model		SHENMAO PF606-P26		

Note : All the temperature measure point is on top surface of the component, if temperature over recommend, it will make component surface peeling or damage.





#### Soldering With Iron:

Soldering condition : Soldering iron temperature  $270\pm10$  °C.

Apply preheating at  $120^{\circ}$ C for 2-3 minutes. Finish soldering for each terminal within 3 seconds, if soldering iron over temperature  $270\pm10^{\circ}$ C or 3 seconds, it will make component surface peeling or damage. Soldering iron can not leakage of electricity.